

ABSTRACT

A release layer 22 is formed on a surface of a
5 first supporting sheet 20. Next, an electrode layer 12a
is formed on a surface of the release layer 22. When the
electrode layer 12a is pressed against a surface of a
green sheet 10a to bond the electrode layer 12a with the
green sheet 10a, an adhesive layer 28 is formed by a
10 transfer method on a surface of the electrode layer 12a
or a surface of the green sheet 10a. It becomes possible
to easily transfer a dry type electrode layer to the
surface of the green sheet with high accuracy without
breaking or deforming the green sheet, moreover,
15 components of the adhesive layer do not soak in the
electrode layer or green sheet. Also, the supporting
sheet is extremely easily released, and a production cost
of a multilayer ceramic capacitor is reduced.

[Selected Drawing] FIG. 3A